



Data sheet acquired from Harris Semiconductor  
 SCHS260A

January 1997

# CD74FCT573, CD74FCT573AT

## BiCMOS FCT Interface Logic, Octal Transparent Latches, Three-State

### Features

- Buffered Inputs
- Typical Propagation Delay: 3.9ns at  $V_{CC} = 5V$ ,  $T_A = 25^\circ C$ ,  $C_L = 50pF$  (CD74FCT573AT)
- SCR Latchup Resistant BiCMOS Process and Circuit Design
- FCTXXX Types
  - Speed of Bipolar FAST™/AS/S
- FCTXXXAT Types
  - 30% Faster than FAST™/AS/S with Significantly Reduced Power Consumption
- 48mA Output Sink Current
- Output Voltage Swing Limited to 3.7V at  $V_{CC} = 5V$
- Controlled Output Edge Rates
- Input/Output Isolation to  $V_{CC}$
- BiCMOS Technology with Low Quiescent Power

**NOT RECOMMENDED  
FOR NEW DESIGNS**  
 Use CMOS Technology

### Description

The CD74FCT573 and CD74FCT573AT octal transparent latches use a small geometry BiCMOS technology. The output stage is a combination of bipolar and CMOS transistors that limits the output HIGH level to two diode drops below  $V_{CC}$ . This resultant lowering of output swing (0V to 3.7V) reduces power bus ringing (a source of EMI) and minimizes  $V_{CC}$  bounce and ground bounce and their effects during simultaneous output switching. The output configuration also enhances switching speed and is capable of sinking 48 milliamperes.

The CD74FCT573 and CD74FCT573AT outputs are transparent to the inputs when the Latch Enable ( $\overline{LE}$ ) is HIGH. When the Latch Enable ( $\overline{LE}$ ) goes LOW, the data is latched. The Output Enable ( $\overline{OE}$ ) controls the three-state outputs. When the Output Enable ( $\overline{OE}$ ) is HIGH, the outputs are in the high impedance state. The latch operation is independent of the state of the Output Enable.

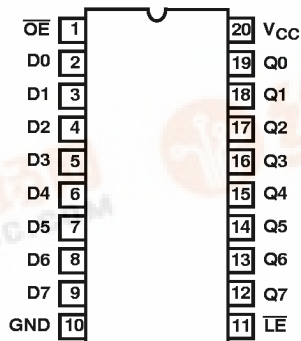
### Ordering Information

PART NUMBER	TEMP. RANGE ( $^\circ C$ )	PACKAGE	PKG. NO.
CD74FCT573ATE	0 to 70	20 Ld PDIP	E20.3
CD74FCT573M	0 to 70	20 Ld SOIC	M20.3
CD74FCT573SM	0 to 70	20 Ld SSOP	M20.209

NOTE: When ordering the suffix M and SM packages, use the entire part number. Add the suffix 96 to obtain the variant in the tape and reel.

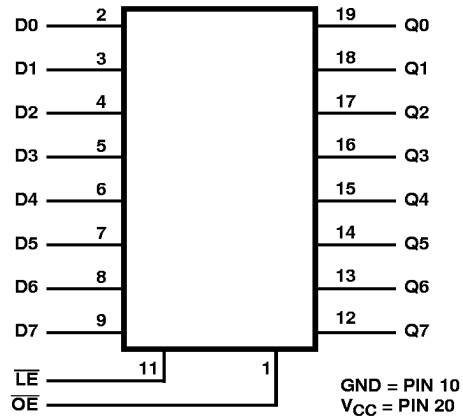
### Pinout

CD74FCT573, CD74FCT573AT  
 (PDIP, SOIC, SSOP)  
 TOP VIEW



## CD74FCT573, CD74FCT573AT

### Functional Diagram



TRUTH TABLE (Note 1)

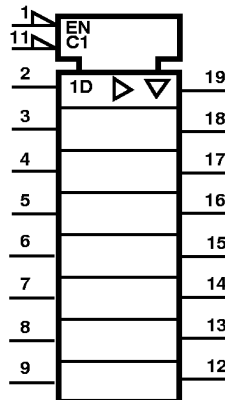
OUTPUT ENABLE	LATCH ENABLE	DATA	OUTPUT
L	H	H	H
L	H	L	L
L	L	l	L
L	L	h	H
H	X	X	Z

NOTE:

1. H = HIGH Voltage Level  
 L = LOW Voltage Level  
 l = Low voltage level one set up time prior to the high to low latch enable transition.  
 h = High voltage level one set up time prior to the high to low latch enable transition.  
 X = Irrelevant  
 Z = High Impedance

### IEC Logic Symbol

CD74FCT573, CD74FCT573AT



## CD74FCT573, CD74FCT573AT

### Absolute Maximum Ratings

DC Supply Voltage ( $V_{CC}$ )	-0.5V to 6V
DC Input Diode Current, $I_{IK}$ (For $V_I < -0.5V$ )	-20mA
DC Output Diode Current, $I_{OK}$ (for $V_O < -0.5V$ )	-50mA
DC Output Sink Current per Output Pin, $I_O$	70mA
DC Output Source Current per Output Pin, $I_O$	-30mA
DC $V_{CC}$ Current ( $I_{CC}$ )	140mA
DC Ground Current ( $I_{GND}$ )	400mA

### Thermal Information

Thermal Resistance (Typical, Note 2)	$\theta_{JA}$ ( $^{\circ}C/W$ )
PDIP Package	135
SOIC Package	125
SSOP Package	130
Maximum Junction Temperature	150 $^{\circ}C$
Maximum Storage Temperature Range	-65 $^{\circ}C$ to 150 $^{\circ}C$
Maximum Lead Temperature (Soldering 10s)	300 $^{\circ}C$ (SOIC and SSOP-Lead Tips Only)

### Operating Conditions

Operating Temperature Range ( $T_A$ )	0 $^{\circ}C$ to 70 $^{\circ}C$
Supply Voltage Range, $V_{CC}$	4.75V to 5.25V
DC Input Voltage, $V_I$	0 to $V_{CC}$
DC Output Voltage, $V_O$	0 to $\leq V_{CC}$
Input Rise and Fall Slew Rate, $dt/dv$	0 to 10ns/V

**CAUTION:** Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

NOTE:

- $\theta_{JA}$  is measured with the component mounted on an evaluation PC board in free air.

### Electrical Specifications Commercial Temperature Range 0 $^{\circ}C$ to 70 $^{\circ}C$ , $V_{CC}$ Max = 5.25V, $V_{CC}$ Min = 4.75V (Note 5)

PARAMETER	SYMBOL	TEST CONDITIONS		V <sub>CC</sub> (V)	AMBIENT TEMPERATURE (T <sub>A</sub> )				UNITS
					25°C		0°C TO 70°C		
		V <sub>I</sub> (V)	I <sub>O</sub> (mA)		MIN	MAX	MIN	MAX	
High Level Input Voltage	V <sub>IH</sub>			4.75 to 5.25	2	-	2	-	V
Low Level Input Voltage	V <sub>IL</sub>			4.75 to 5.25	-	0.8	-	0.8	V
High Level Output Voltage	V <sub>OH</sub>	V <sub>IH</sub> or V <sub>IL</sub>	-15	Min	2.4	-	2.4	-	V
Low Level Output Voltage	V <sub>OL</sub>	V <sub>IH</sub> or V <sub>IL</sub>	48	Min	-	0.55	-	0.55	V
High Level Input Current	I <sub>IH</sub>	V <sub>CC</sub>		Max	-	0.1	-	1	μA
Low Level Input Current	I <sub>IL</sub>	GND		Max	-	-0.1	-	-1	μA
Three-State Leakage Current	I <sub>OZH</sub>	V <sub>CC</sub>		Max	-	0.5	-	10	μA
	I <sub>OZL</sub>	GND		Max	-	-0.5	-	-10	μA
Input Clamp Voltage	V <sub>IK</sub>	V <sub>CC</sub> or GND	-18	Min	-	-1.2	-	-1.2	V
Short Circuit Output Current (Note 3)	I <sub>OS</sub>	V <sub>O</sub> = 0 V <sub>CC</sub> or GND		Max	-60	-	-60	-	mA
Quiescent Supply Current, MSI	I <sub>CC</sub>	V <sub>CC</sub> or GND	0	Max	-	8	-	80	μA
Additional Quiescent Supply Current per Input Pin TTL Inputs High, 1 Unit Load	ΔI <sub>CC</sub>	3.4V (Note 4)		Max	-	1.6	-	1.6	mA

NOTES:

- Not more than one output should be shorted at one time. Test duration should not exceed 100ms.
- Inputs that are not measured are at  $V_{CC}$  or GND.
- FCT Input Loading: All inputs are 1 unit load. Unit load is  $\Delta I_{CC}$  limit specified in Electrical Specifications table, e.g., 1.6mA Max. at 70 $^{\circ}C$ .

## CD74FCT573, CD74FCT573AT

### Switching Specifications Over Operating Range FCT Series $t_r, t_f = 2.5\text{ns}$ , $C_L = 50\text{pF}$ , $R_L$ (Figure 4) (Note 6)

PARAMETER	SYMBOL	$V_{CC}$ (V)	25°C	0°C TO 70°C		UNITS
			TYP	MIN	MAX	
Propagation Delays						
Data to Outputs						
CD74FCT573	$t_{PLH}, t_{PHL}$	5	5	1.5	8	ns
CD74FCT573AT	$t_{PLH}, t_{PHL}$	5	3.9	1.5	5.7	ns
$\overline{LE}$ to Outputs						
CD74FCT573	$t_{PLH}, t_{PHL}$	5	9	2	13	ns
CD74FCT573AT	$t_{PLH}, t_{PHL}$	5	4.4	2	7	ns
Output Enable Times						
CD74FCT573	$t_{PZL}, t_{PZH}$	5	7	1.5	12	ns
CD74FCT573AT	$t_{PZL}, t_{PZH}$	5	6	1.5	8	ns
Output Disable Times						
CD74FCT573	$t_{PLZ}, t_{PHZ}$	5	6	1.5	7.5	ns
CD74FCT573AT	$t_{PLZ}, t_{PHZ}$	5	4	1.5	5.8	ns
Power Dissipation Capacitance	$C_{PD}$ (Note 7)	-	34	-	-	pF
Minimum (Valley) $V_{OHV}$ During Switching of Other Outputs (Output Under Test Not Switching)	$V_{OHV}$ (Figure 1)	5	0.5	-	-	V
Maximum (Peak) $V_{OLP}$ During Switching of Other Outputs (Output Under Test Not Switching)	$V_{OLP}$ (Figure 1)	5	1	-	-	V
Input Capacitance	$C_I$	-	-	-	10	pF
Three-State Output Capacitance	$C_O$	-	-	-	15	pF

#### NOTES:

6. 5V: Min is at 5.25V for 0°C to 70°C, Max is at 4.75V for 0°C to 70°C, Typ is at 5V.
7.  $C_{PD}$ , measured per flip-flop, is used to determine the dynamic power consumption.  
 $P_D$  (per package) =  $V_{CC} I_{CC} + \Sigma(V_{CC}^2 f_I C_{PD} + V_O^2 f_O C_L + V_{CC} \Delta I_{CC} D)$  where:  
 $V_{CC}$  = supply voltage  
 $\Delta I_{CC}$  = flow through current x unit load  
 $C_L$  = output load capacitance  
 $D$  = duty cycle of input high  
 $f_O$  = output frequency  
 $f_I$  = input frequency

#### Prerequisite for Switching

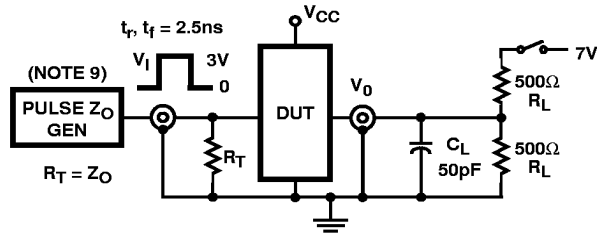
PARAMETER	SYMBOL	$V_{CC}$ (V)	25°C	0°C TO 70°C		UNITS
			TYP	MIN	MAX	
Data to Latch Enable Setup Time	$t_{SU}$	5 (Note 8)	-	2	-	ns
Data to Latch Enable Hold Time	$t_{H}$	5	-	1.5	-	ns
Latch Enable Pulse Width						
CD74FCT573	$t_W$	5	-	6	-	ns
CD74FCT573AT	$t_W$	5	-	5	-	ns

#### NOTE:

8. 5V: Minimum is at 4.75V for 0°C to 70°C, Typical is at 5V.

# CD74FCT573, CD74FCT573AT

## Test Circuits and Waveforms



NOTE:

9. Pulse Generator for All Pulses: Rate  $\leq 1.0\text{MHz}$ ;  $Z_{OUT} \leq 50\Omega$ ;  
 $t_r, t_f \leq 2.5\text{ns}$ .

FIGURE 1. TEST CIRCUIT

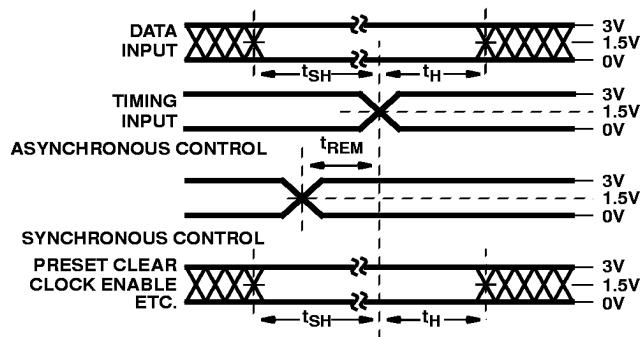


FIGURE 2. SETUP, HOLD, AND RELEASE TIMING

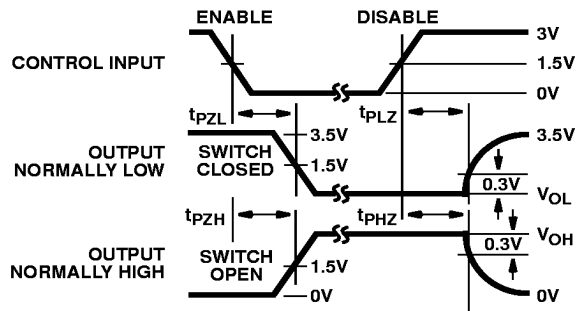


FIGURE 4. ENABLE AND DISABLE TIMING

SWITCH POSITION	
TEST	SWITCH
$t_{PLZ}, t_{PZL}, \text{Open Drain}$	Closed
$t_{PHZ}, t_{PZH}, t_{PLH}, t_{PHL}$	Open

DEFINITIONS:

$C_L$  = Load capacitance, includes jig and probe capacitance.

$R_T$  = Termination resistance, should be equal to  $Z_{OUT}$  of the Pulse Generator.

$V_{IN} = 0\text{V to } 3\text{V}$ .

Input:  $t_r = t_f = 2.5\text{ns}$  (10% to 90%), unless otherwise specified

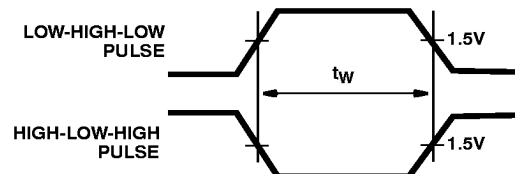


FIGURE 3. PULSE WIDTH

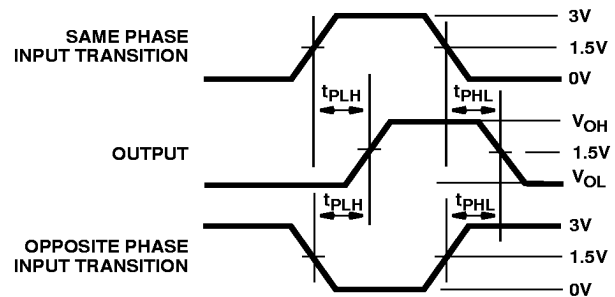
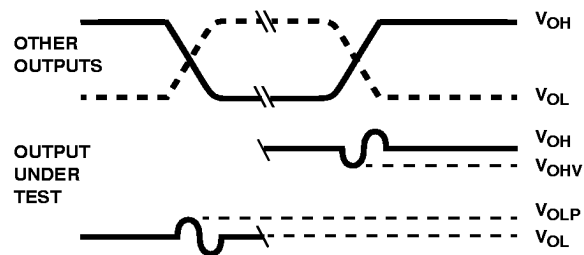


FIGURE 5. PROPAGATION DELAY

## Test Circuits and Waveforms (Continued)



### NOTES:

10.  $V_{OLP}$  is measured with respect to a ground reference near the output under test.  $V_{OHV}$  is measured with respect to  $V_{OH}$ .
11. Input pulses have the following characteristics:  
 $P_{RR} \leq 1\text{MHz}$ ,  $t_r = 2.5\text{ns}$ ,  $t_f = 2.5\text{ns}$ , skew 1ns.
12. R.F. fixture with 700MHz design rules required. IC should be soldered into test board and bypassed with 0.1 $\mu\text{F}$  capacitor. Scope and probes require 700MHz bandwidth.

**FIGURE 6. SIMULTANEOUS SWITCHING TRANSIENT WAVEFORMS**